

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MMST4401

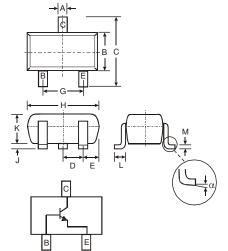
NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMST4403)
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking Information: K3X See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.006 grams (approximate)



SOT-323											
Dim	Min	Max									
Α	0.25	0.40									
В	1.15	1.35									
С	2.00	2.20									
D	D 0.65 Nominal										
E	0.30	0.40									
G	1.20	1.40									
Н	1.80	2.20									
J	0.0	0.10									
K	0.90 1.										
L	0.25	0.40 0.18									
М	0.10										
α	0°	8°									
All Dimensions in mm											

Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Collector-Base Voltage	V _{CBO}	60	V		
Collector-Emitter Voltage	V _{CEO}	40	V		
Emitter-Base Voltage	V _{EBO}	6.0	V		
Collector Current – Continuous (Note 1)	Ic	600	mA		
Power Dissipation (Note 1)	Pd	200	mW		
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ hetaJA}$	625	°C/W		
Operating and Storage Temperature Range	T _j , T _{STG}	-55 to +150	°C		

Notes:

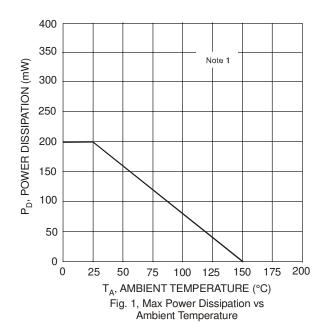
- 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

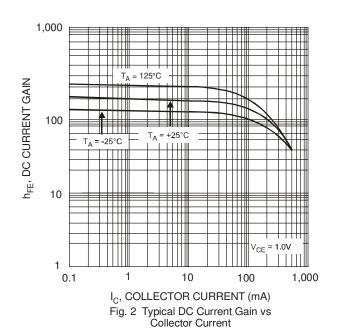


Electrical Characteristics @T_A = 25°C unless otherwise specified

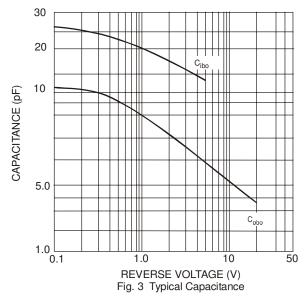
Characteristic	Symbol	Min	Max	Unit	Test Condition				
OFF CHARACTERISTICS (Note 5)									
Collector-Base Breakdown Voltage	V _{(BR)CBO}	60		V	$I_C = 100 \mu A, I_E = 0$				
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	40	_	V	$I_C = 1.0 \text{mA}, I_B = 0$				
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6.0	_	V	$I_E = 100 \mu A, I_C = 0$				
Collector Cutoff Current	I _{CEX}	_	100	nA	$V_{CE} = 35V, V_{EB(OFF)} = 0.4V$				
Base Cutoff Current	I _{BL}	_	100	nA	$V_{CE} = 35V$, $V_{EB(OFF)} = 0.4V$				
ON CHARACTERISTICS (Note 5)				•					
		20	_		$I_C = 100 \mu A, V_{CE} = 1.0 V$				
		40	_		$I_C = 1.0 \text{mA}, V_{CE} = 1.0 \text{V}$				
DC Current Gain	h _{FE}	80	_	_	$I_C = 10 \text{mA}, V_{CE} = 1.0 \text{V}$				
		100	300		$I_C = 150 \text{mA}, V_{CE} = 1.0 \text{V}$				
		40			$I_C = 500 \text{mA}, V_{CE} = 2.0 \text{V}$				
Collector-Emitter Saturation Voltage	Vorcet		0.40	V	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$				
Collector-Entitler Cataration Voltage	V _{CE(SAT)}		0.75	V	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$				
Base-Emitter Saturation Voltage	V	0.75	0.95	V	$I_C = 150 \text{mA}, I_B = 15 \text{mA}$				
, and the second	V _{BE(SAT)}	_	1.2	V	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$				
SMALL SIGNAL CHARACTERISTICS	,								
Output Capacitance	C _{ob}	_	8.5	pF	$V_{CB} = 5.0V$, $f = 1.0MHz$, $I_E = 0$				
Input Capacitance	C _{eb}	_	30	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_{C} = 0$				
Input Impedance	h _{ie}	1.0	15	kΩ					
Voltage Feedback Ratio	h _{re}	0.1	8.0	x 10 ⁻⁴	V _{CE} = 10V, I _C = 1.0mA,				
Small Signal Current Gain	h _{fe}	40	500	_	f = 1.0MHz				
Output Admittance	h _{oe}	1.0	30	μS					
Current Gain-Bandwith Product	f _T	250	_	MHz	$V_{CE} = 10V, I_{C} = 20mA,$ f = 100MHz				
SWITCHING CHARACTERISTICS				•					
Delay Time	t _d		15	ns	V _{CC} = 30V, I _C = 150mA,				
Rise Time	t _r		20	ns	$V_{BE(OFF)} = 2.0V, I_{B1} = 15mA$				
Storage Time	ts		225	ns	V _{CC} = 30V, I _C = 150mA,				
Fall Time	t _r	_	30	ns	$I_{B1} = I_{B2} = 15mA$				

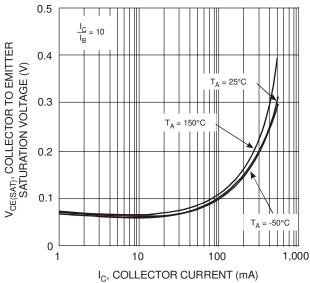
^{5.} Short duration pulse test used to minimize self-heating effect.

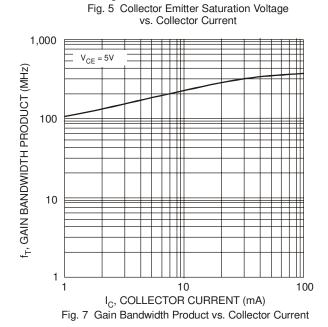












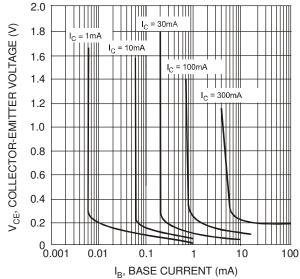


Fig. 4 Typical Collector Saturation Region

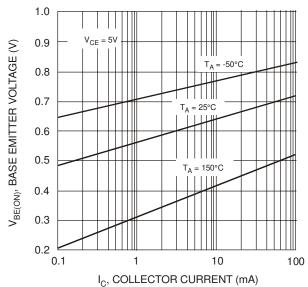


Fig. 6 Base Emitter Voltage vs. Collector Current

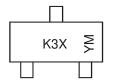


Ordering Information (Note 4 & 6)

Device	Packaging	Shipping			
MMST4401-7-F	SOT-323	3000/Tape & Reel			

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



K3X = Product Type Marking Code

YM = Date Code Marking Y = Year ex: N = 2002

M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Fel	b	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		N	D

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